

UT6898

Power MOSFET

N-CHANNEL ENHANCEMENT

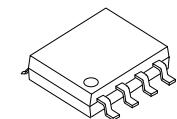
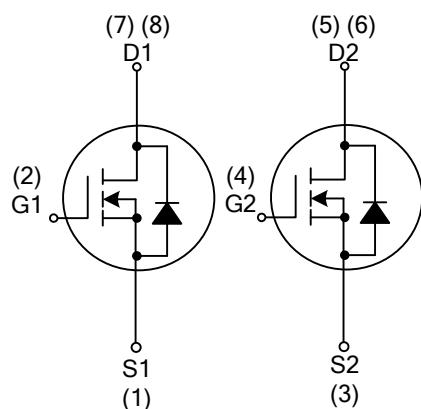
■ DESCRIPTION

The **UT6898** uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with low gate voltages. This device is suitable for use as a load switch or in PWM applications.

■ FEATURES

- * $R_{DS(ON)} < 18 \text{ m}\Omega @ V_{GS} = 2.5V$
- * $R_{DS(ON)} < 14 \text{ m}\Omega @ V_{GS} = 4.5V$
- * Low capacitance
- * Low gate charge
- * Fast switching capability
- * Avalanche energy specified

■ SYMBOL



SOP-8

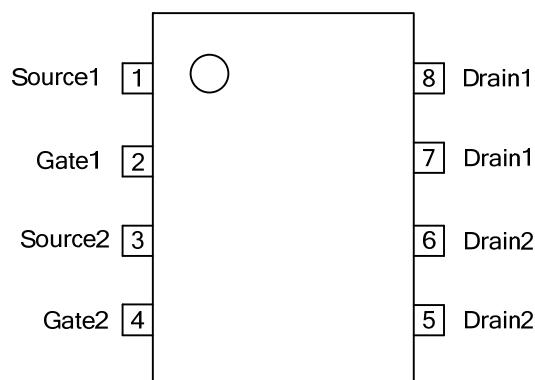
Lead-free: UT6898L
Halogen-free: UT6898G

■ ORDERING INFORMATION

| Ordering Number | | | Package | Packing |
|-----------------|---------------|---------------|---------|-----------|
| Normal | Lead Free | Halogen Free | | |
| UT6898-S08-R | UT6898L-S08-R | UT6898G-S08-R | SOP-8 | Tape Reel |
| UT6898-S08-T | UT6898L-S08-T | UT6898G-S08-T | SOP-8 | Tube |

| | | |
|---------------|-----------------|--|
| UT6898L-S08-R | (1)Packing Type | (1) R: Tape Reel, T: Tube |
| | (2)Package Type | (2) S08: SOP-8 |
| | (3)Lead Plating | (3) G: Halogen Free, L: Lead Free, Blank: Pb/Sn |

■ PIN CONFIGURATION



■ SOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$, unless otherwise specified)

| PARAMETER | SYMBOL | RATINGS | UNIT |
|---------------------------|-----------|------------|------------------|
| Drain-Source Voltage | V_{DSS} | 20 | V |
| Gate-Source Voltage | V_{GSS} | ± 12 | V |
| Continuous Drain Current | I_D | 9.4 | A |
| Pulsed Drain Current | I_{DM} | 38 | A |
| Maximum Power Dissipation | P_D | 2 | W |
| Junction Temperature | T_J | +150 | $^\circ\text{C}$ |
| Storage Temperature | T_{STG} | -55 ~ +150 | $^\circ\text{C}$ |

Note: Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

■ THERMAL DATA

| PARAMETER | SYMBOL | MIN | TYP | MAX | UNIT |
|------------------|---------------|-----|-----|-----|---------------------------|
| Junction-to-Case | θ_{JC} | | 40 | | $^\circ\text{C}/\text{W}$ |

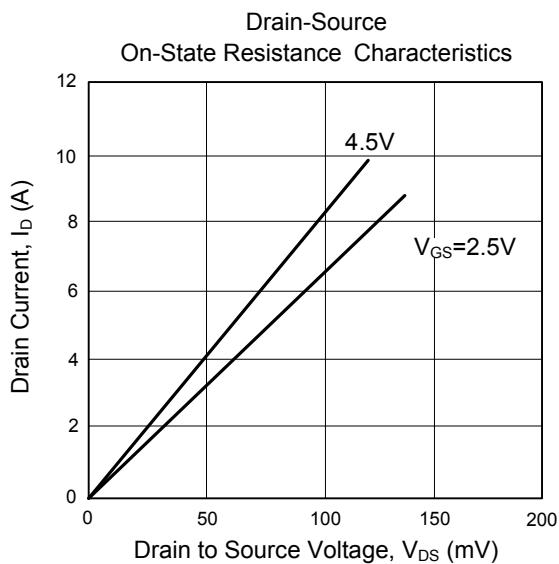
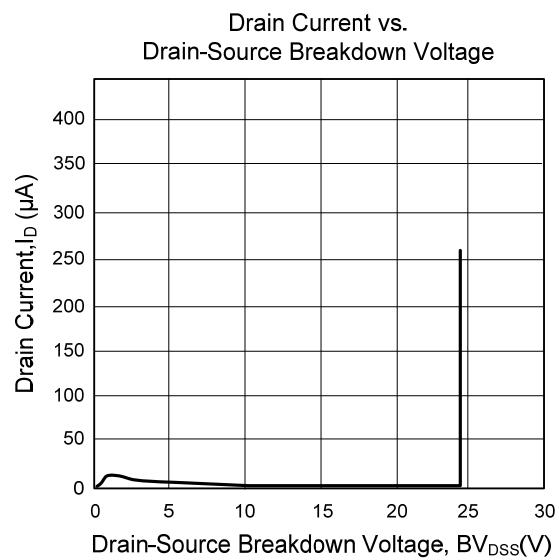
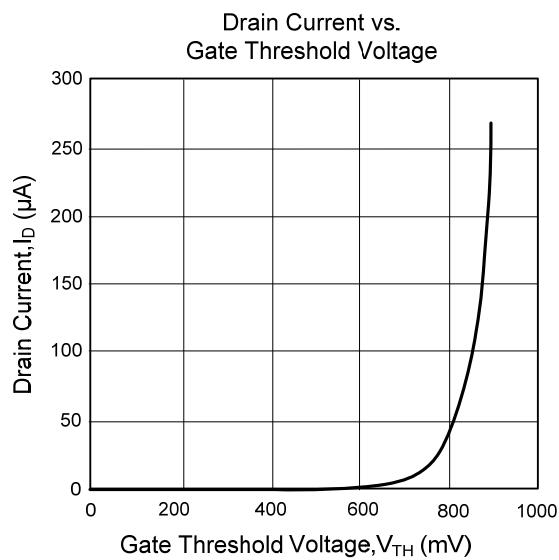
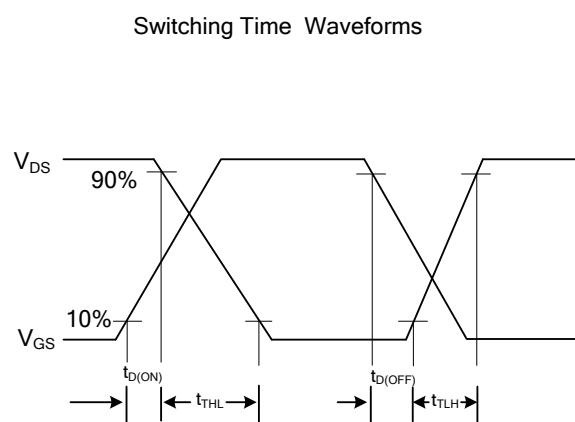
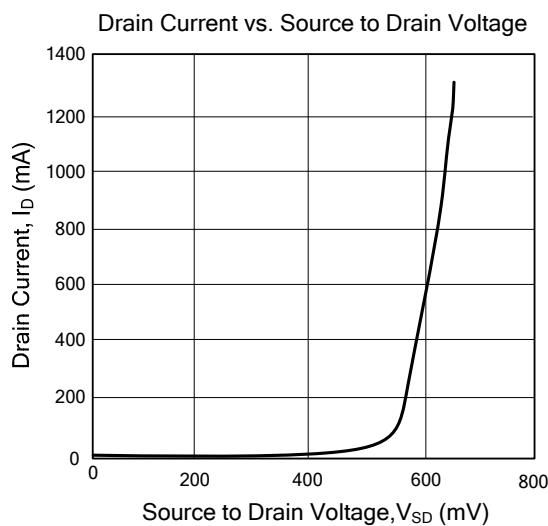
■ ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$, unless otherwise specified)

| PARAMETER | SYMBOL | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|--|---------------------|--|-----|------|-----------|------------------|
| OFF CHARACTERISTICS | | | | | | |
| Drain-Source Breakdown Voltage | BV_{DSS} | $V_{GS}=0\text{V}, I_D=250\mu\text{A}$ | 20 | | | V |
| Drain-Source Leakage Current | I_{DS} | $V_{GS}=0\text{V}, V_{DS}=16\text{V}$ | | | 1 | μA |
| Gate-Source Leakage Current | I_{GSS} | $V_{GS}=\pm 12\text{V}, V_{DS}=0\text{V},$ | | | ± 100 | nA |
| ON CHARACTERISTICS (Note 1) | | | | | | |
| Gate Threshold Voltage | $V_{GS(\text{TH})}$ | $V_{DS}=V_{GS}, I_D=250\mu\text{A}$ | 0.5 | 1 | 1.5 | V |
| On State Drain Current | $I_{D(\text{ON})}$ | $V_{GS}=4.5\text{ V}, V_{DS}=5\text{V},$ | 19 | | | A |
| Drain-Source On-State Resistance | $R_{DS(\text{ON})}$ | $V_{GS}=4.5\text{V}, I_D=9.4\text{A}$ $V_{GS}=2.5\text{V}, I_D=8.3\text{A}$ | | 10 | 14 | $\text{m}\Omega$ |
| DYNAMIC CHARACTERISTICS | | | | | | |
| Input Capacitance | C_{ISS} | $V_{GS}=0\text{V}, V_{DS}=10\text{V}, f=1\text{MHz}$ | | 1821 | | pF |
| Output Capacitance | C_{OSS} | | | 440 | | pF |
| Reverse Transfer Capacitance | C_{RSS} | | | 208 | | pF |
| SWITCHING PARAMETERS (Note 1) | | | | | | |
| Turn-ON Delay Time | $t_{D(\text{ON})}$ | $V_{GS}=4.5\text{V}, V_{DS}=10\text{V}, I_D=1\text{A}$ $R_{\text{GEN}}=6\Omega$ | | 10 | 20 | ns |
| Turn-ON Rise Time | t_R | | | 15 | 27 | ns |
| Turn-OFF Delay Time | $t_{D(\text{OFF})}$ | | | 34 | 55 | ns |
| Turn-OFF Fall-Time | t_F | | | 16 | 29 | ns |
| Total Gate Charge | Q_G | $V_{GS}=4.5\text{V}, V_{DS}=10\text{V},$ $I_D=9.4\text{A}$ | | 16 | 23 | nC |
| Gate Source Charge | Q_{GS} | | | 3 | | nC |
| Gate Drain Charge | Q_{GD} | | | 4 | | nC |
| SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS | | | | | | |
| Drain-Source Diode Forward Voltage | V_{SD} | $V_{GS}=0\text{V}, I_S=1.3\text{A}$ (Note 1) | | | 1.3 | V |
| Maximum Continuous Drain-Source Diode Forward Current | I_S | | | 0.7 | 1.2 | A |

Notes: 1. Pulse Test: Pulse Width < 300ms, Duty Cycle < 2.0%

2. The diode connected between the gate and source serves only as protection against ESD. No gate overvoltage rating is implied

■ TYPICAL CHARACTERISTICS



UTC assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all UTC products described or contained herein. UTC products are not designed for use in life support appliances, devices or systems where malfunction of these products can be reasonably expected to result in personal injury. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner. The information presented in this document does not form part of any quotation or contract, is believed to be accurate and reliable and may be changed without notice.

